



Date issued : August 30, 2018

Bulletin

We, CHI MEI CORPORATION, to the best of our knowledge hereby certify that the resins listed below (hereinafter referred as "products") as directly manufactured by us

POLYLAC® ABS (J01)

PA-705, PA-707, PA-757, PA-757F, PA-757N, PA-717C, PA-726, PA-726M, PA-727, PA-747, PA-709, PA-797, PA-756, PA-756S, PA-756H, PA-716, PA-746, PA-746H, PA-737, PA-747H, PA-747R, PA-747F, PA-747S, PA-709S, PA-709P, PA-709K, PA-709H, PA-797S, PA-777B, PA-777C, PA-777D, PA-777E, PA-757K, PA-757GJ08, PA-718, PA-746Y, PA-757 A01, PA-747S A01, PA-749, PA-749S, PA-757H, PA-737 A03, PA-77NB, PA-797, PA-746M

(J01) - The suffix may be used to denote the black color grade manufactured from Chi Mei Corp.

(A01 & A03) - The suffix may be used to denote the white color grade manufactured from Chi Mei Corp.

POLYLAC® MABS

KIBISAN® SAN

PA-758, PA-758R, LS-L230

PN-106, PN-106 L150 FG, PN-107, PN-117, PN-117C, PN-117C FG, PN-117H, PN-117H L150 FG, PN-127, PN-127H, PN-137H, PN-107 L125 FG, PN-127 L100 FG, PN-106L150 FG, PN-117L100 FG, PN-117 L200 FG

POLYREX® PS

PG-22, PG-33, PG-80N, PG-80, PG-383, PG-383D, PH-55Y, PH-60, PH-88, PH-888H, PH-888G, PH-88S, PH-88SF

ACRYREX® PMMA

ACRYSTEX® SMMA

KIBITON® TPE

KIBITON® Q-resin

KIBIPOL® LBR/SSBR/HBR

ACRYPOLY®

KIBILITE®

CM-203, CM-205, CM-205G, CM-205N, CM-207, CM-207G, CM-211, CM-211G

PM-600, PM-500, PM-500G, PM-700G

PB-575, PB-585, PB-587, PB-511, PB-5300, PB-5301, PB-5302, PB-5308, PB-5502

PB-5903, PB-5910, PB-5925, PB-5900, PB-5630, PB-5906

PR-245, PR-255, PR-1205, PR-040, PR-040S, PR-040G, PR-040C, PR-050, PR-303

CM-205X, CM-205B, LM-700X, PM-500X

DC-553F, DC-603F, DS-553A, DS-603A, DS-743B, DM-553B, DC-552F, DC-552G, DS-653A, DS-553C, DS-603C, DS-653C, DS-753B, DM-000B, DS-903A, DS-943A, DS-943B, DS-903E, DS-963E, DS-943G, DS-963G, DS-903H, DS-943H, DS-943I, DS-553H, DM-601M, DM-601R, DM-551M, DS-601S, DS-601Y, DS-551A

KIBILAC®

PW-957, PW-978B, PW-997S, PW-997, PW-997G

contain no following substances.

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|---|--|
| 1. Halogen (F, Br, I) and its compounds | 33. Radioactive Substances |
| 2. Halogen (Cl) | 34. Natural Latex |
| 3. PBDEs (Polybrominated Diphenyl Ethers) | 35. Dioxins and furans |
| 4. PBBs (Polybrominated Biphenyls) | 36. Primary aromatic amines (PAA) |
| 5. Ozone Depleting Chemicals (CFCs & HCFCs) | 37. Perchlorate |
| 6. Chlorinated Paraffin (C10-C13) | 38. Hexachlorobenzene |
| 7. Polyvinyl Chloride (PVC) | 39. Mirex |
| 8. Mercury (Hg) and its compounds | 40. Specified amine compounds |
| 9. Lead (Pb) and its compounds | 41. Benzene |
| 10. Cadmium (Cd) and its compounds | 42. Benzenamine, <i>N</i> -phenyl-, Reaction Products with Styrene and 2,4,4-Trimethylpentene (BNST) |
| 11. Chromium (Cr) and its compounds | 43. Polyamide |
| 12. Arsenic (As) and its compounds | 44. PVDC (polyvinylidene chloride) |
| 13. Antimony (Sb) and its compounds | |

The above statement is based on our current level of knowledge and covers the above products directly manufactured and supplied by CHI MEI CORPORATION at the date of issue. CHI MEI CORPORATION makes no warranties, whether express or implied, and assumes no liability in connection with any use of above information. Notwithstanding the foregoing, CHI MEI CORPORATION shall in no event be held obligated or liable for any claims due to or arising from (i) any customer provided, consigned, materials and/or parts, which are incorporated or adopted in the products; (ii) any combination of the products with material not provided or authorized by our company; (iii) any modifications to the products which are made or directed by customer; (iv) our compliance with the specifications, instructions, and/or designs provided by customer; (v) any anti-trust, unfair competition and/or other unlawful actions effected by customer; or (vi) any defects, infringement, breach and/or violation which are arising out of customer's faults or otherwise not solely and directly attributable to CHI MEI CORPORATION. In no event will CHI MEI CORPORATION be liable for any indirect, special, exemplary, punitive, or consequential damages (including lost profits) of any nature whatsoever whether arising out of the purchase, shipment, unloading, handling, or use of any product or otherwise.



14. Selenium (Se) and its compounds
15. Barium (Ba) and its compounds
16. Beryllium (Be) and its compounds
17. Bismuth (Bi) and its compounds
18. Organic tin compounds (TBT, TPT, DOT, DBT)
19. Polychlorinated Biphenyls (PCBs) and Terphenyls (PCTs) and Naphtalenes (PCNs)
20. Poly naphthalenes
21. Azo colorants (according to REACH-ANNEX-XVII-APPENDIX 8)
22. Asbestos
23. Phthalates
24. APEO: Including Alkylphenol(AP), Octylphenol(OP), Nonylphenol(NP), Octylphenol ethoxylates(OPE), Nonylphenol ethoxylates(NPE)
25. 2-(2'-Hydroxy-3',5'-di-tert-butylphenyl)benzotriazole
26. PFOA, PFOS
27. Bisphenol A
28. Formaldehyde
29. Dimethylfumarate (DMF)
30. Triclosan
31. Nickel
32. REACH- Candidate List of SVHC
45. ESBO (Expoxidized soybean oil)
46. Formamide
47. Hexabromocyclododecane (HBCDD)
48. Red phosphorus
49. Aniline • formaldehyde polycondensate
50. Fluorescent powder
51. 4,4'-Sulfonyldiphenol (BPS)
52. Tris(1-chloro-2-propyl)phosphate (TCPP)
53. Tris(1,3-dichloro-2-propyl)phosphate (TDCPP)
54. Tris (2,3-dibromopropyl) phosphate
55. Tris (aziridiny) phosphin oxide
56. Tri-o-cresyl phosphate
57. Tris (2-chloroethyl) phosphate (TCEP)
58. Perfluorohexane-1-sulphonic acid and its salts (PFHxS)
59. Diisononyl phthalate (DINP)
60. Di-isodecyl phthalate (DIDP)
61. Di-n-octyl phthalate (DnOP)
62. Diethyl phthalate (DEP)
63. Dimethyl phthalate (DMP)
64. Cobalt
65. Mica
66. Graphite
67. Manganese (Mn) and its compounds

With regard to composition of above grades of products, the aforesaid products comply with the Directives of RoHS (2011/65/EU), 2003/11/EC, TCO'07, Blue Angel and SONY Standard (SS-00259).

Sincerely Yours,

Perry D. B. Shiueh

Vice President of R&D Division

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